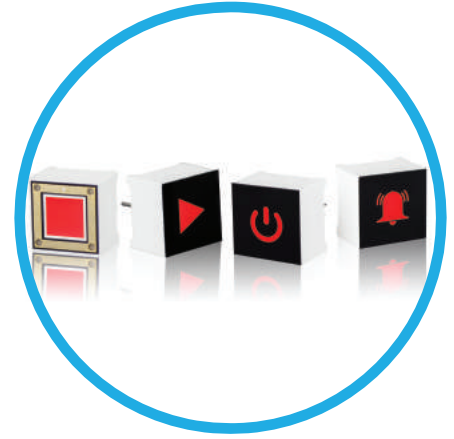




CTH Series

Capacitive Touch Sensor Display

15.0 x 15.0 x 11.0 mm



CTHS15CIC01 - Super Red Capacitive Touch Sensor Through Hole with a Display Size of 0.59 x 0.59 inches (15 x 15 mm) square



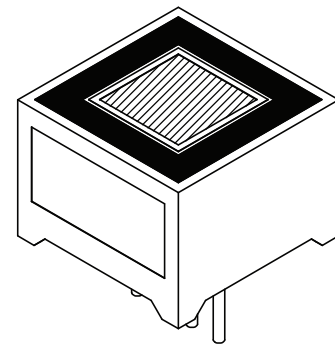
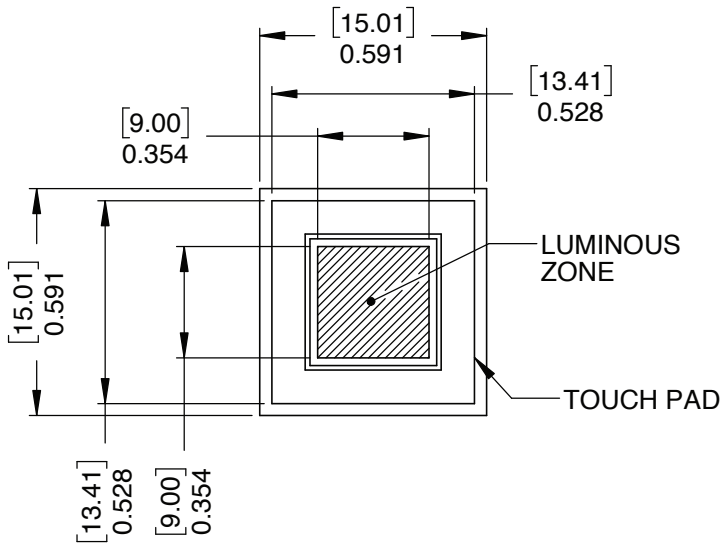
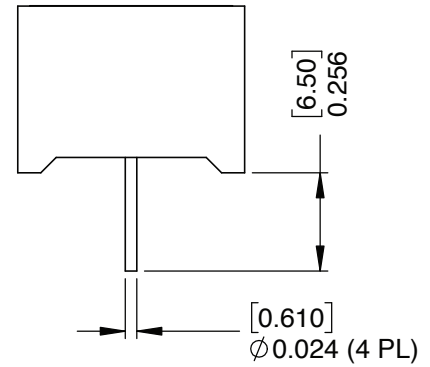
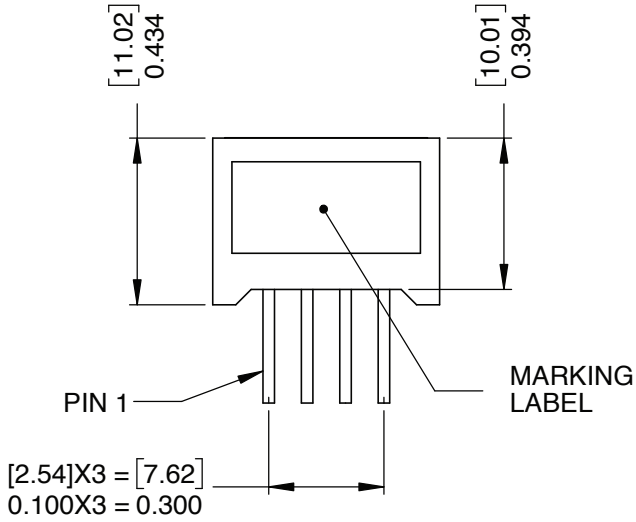
Applications

- Mobile communication devices
- Electronic devices
- Point of sale Terminals
- Gaming
- Industrial control displays
- Touch Screen Monitors
- Portable Instruments
- Media Players
- Medical devices
- Appliances and consumer equipments

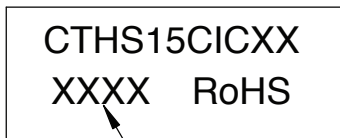
Key Features

- Integrated touch sensing and display technology
- Enables the device interface to be more user friendly and intuitive
- Mounting type: through hole (industry standard pitch 0.100")
- Available in one standard size: 15.0mm x 15.00mm x 11.00mm
- Available in 5 colors: super red, white, pure green, blue or yellow
- Touch sensor: integrated circuit (IC)
- Uniform illumination and high optical clarity due to LED technology
- Robust design due to no mechanical moving parts
- Simplifies devices design and manufacturability
- Optional overlay (icons): on/off, arrow, alarm
- Custom overlay icon can be manufactured upon request - contact VCC
- Compliant with RoHS and REACH requirements

Package Dimensions



MARKING LABEL INFO

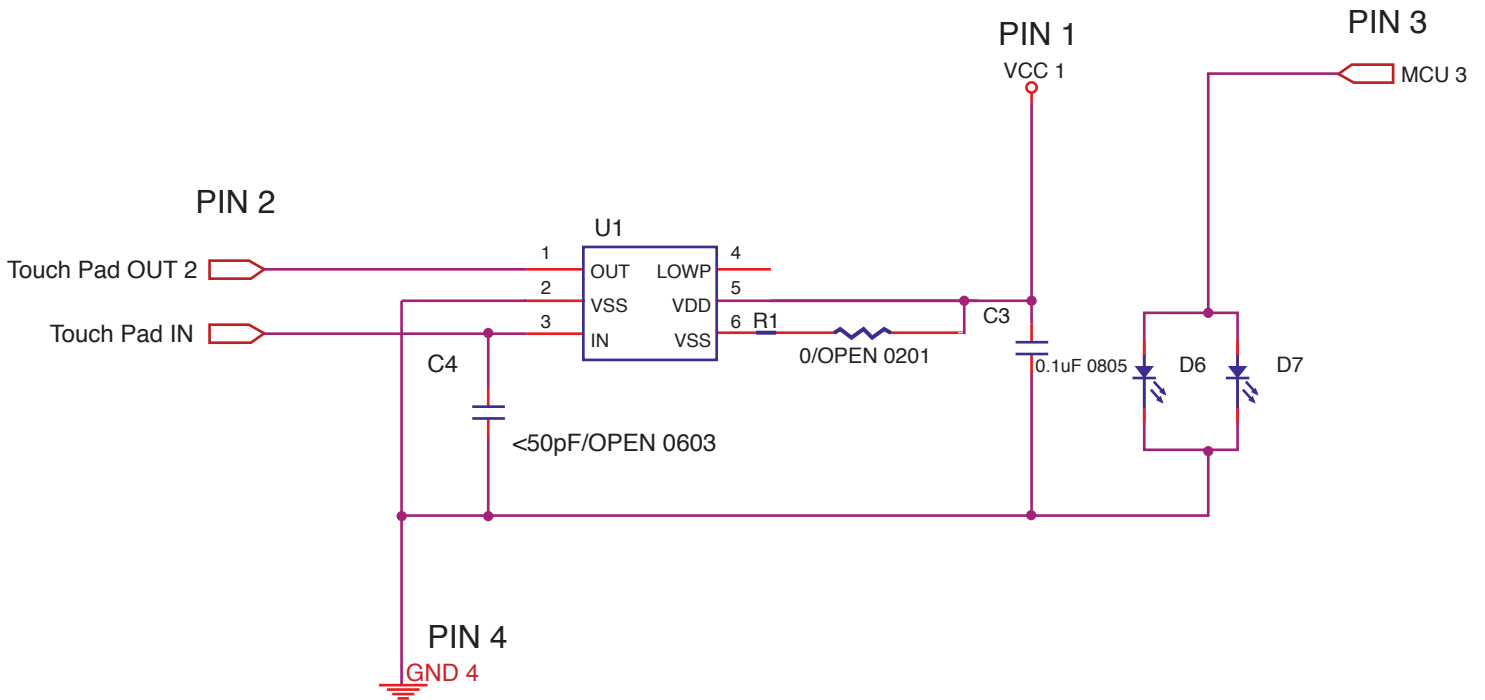


DATE CODE

Dimensions in [mm] inches
General tolerances unless otherwise specified:

	inches	mm
.X	$\pm .020$	$\pm .508$
.XX	$\pm .010$	$\pm .254$
.XXX	$\pm .005$	$\pm .127$

Internal Circuit Diagram



Internal IC Electrical Characteristics

(TA = 25°C, unless otherwise specified)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units.
VDD	Supply Voltage		2.0		5.5	V
VIH	High Level Input Voltage	@ VDD = 5V	0.7VDD		VDD	V
VIL	Low Level Input Voltage	@ VDD = 5V			0.3VDD	V
IDD1	Operating Current	@ VDD = 5V , no load		16		μA
		@ VDD = 3V , no load		3.5		
IDD2	Operating Current (SLRT=VDD)	@ VDD = 5V , no load		10.5		μA
		@ VDD = 3V , no load		2.5		
IOL	Low Level Output Current	@ VDD = 3V, VOL = 1V		30		mA
IOH	High Level Output Current	@ VDD = 3V, VOL = 2V		8		mA

Product Specifications

ABSOLUTE MAXIMUM RATING FOR LED

(Ta=25°C)

Parameter	Symbol	Rating	Unit
		Red	
Power Dissipation Per Dice	PAD	70	mW
Derating Liner from 25°C per Dice	-	0.33	mA/°C
Continuous Forward Current Per Dice	IAF	25	mA
Peak Current Per Dice (duty cycle 1/10,1KHz)	IPF	90	mA
Reverse Voltage Per Dice	VR	5	V
Operating Temp.	Topr	-35 ~ +85	°C
Storage Temp.	Tstg	-35 ~ +85	°C

ELECTRO-OPTICAL CHARACTERISTICS

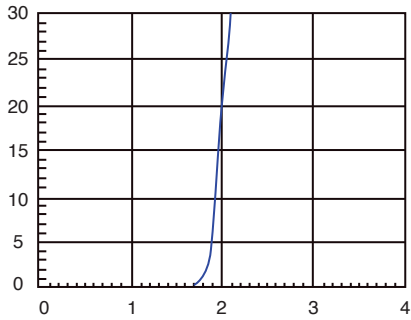
(Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	17	31	--	mcd	IF = 20 mA
Forward Voltage	VF	--	2.0	2.8	V	IF = 20 mA
Peak Emission Wavelength	λP	--	660	--	nm	IF = 20 mA
Dominant Wavelength	λD	--	645	--	nm	IF = 20 mA
Spectrum Radiation Bandwidth	Δλ	--	20	--	nm	IF = 20 mA
Luminous Intensity Matching Ratio	Iv-M	--	-	2 : 1	--	IF = 10 mA
Reverse Current	IR		-	100	μA	VR = 5V

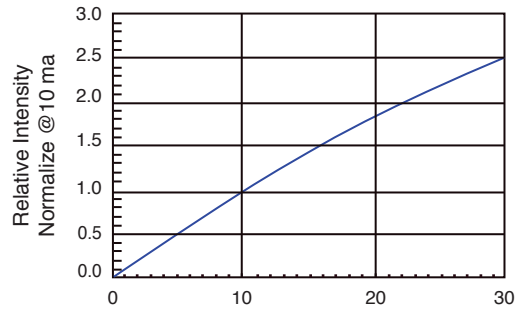
Product Specifications

ELECTRICAL/OPTICAL CHARACTERISTICS CURVES

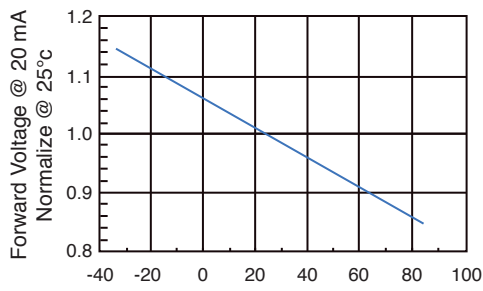
($T_a=25^\circ\text{C}$)



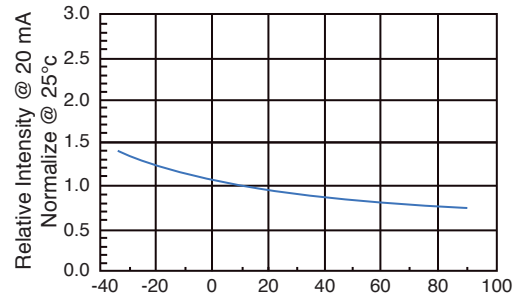
Forward Voltage (V)
Forward Current vs. Forward Voltage



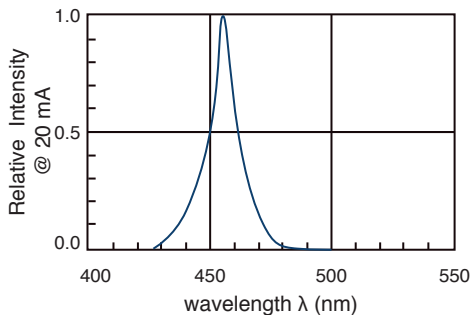
Forward Current (mA)
Relative Intensity vs. Forward Current



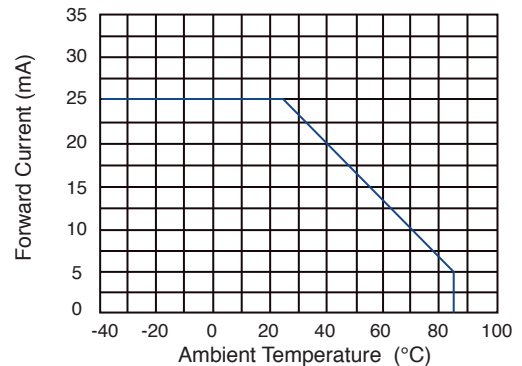
Ambient Temperature ($^\circ\text{C}$)
Forward Voltage vs. Temperature



Ambient Temperature ($^\circ\text{C}$)
Relative Intensity vs. Temperature



wavelength λ (nm)
Relative Intensity vs. Wavelength



Ambient Temperature ($^\circ\text{C}$)
Forward Current vs. Temperature

Product Specifications

SOLDERING CONDITIONS

1. Wave Soldering Profile

Distance: 1.6mm min (From Seating Plane)

Item	Condition		Note
Preheat	Temperature T1	80 – 120 °C	PWB Temperature (Soldering Side Surface)
	Time t1	60 – 180sec	
Solder Dip	Temperature T2	230 – 260°C	Bath Temperature
	Time t2	2 – 4 sec	Solder Tank Passage Time



2. Hand Soldering (Iron Condition)

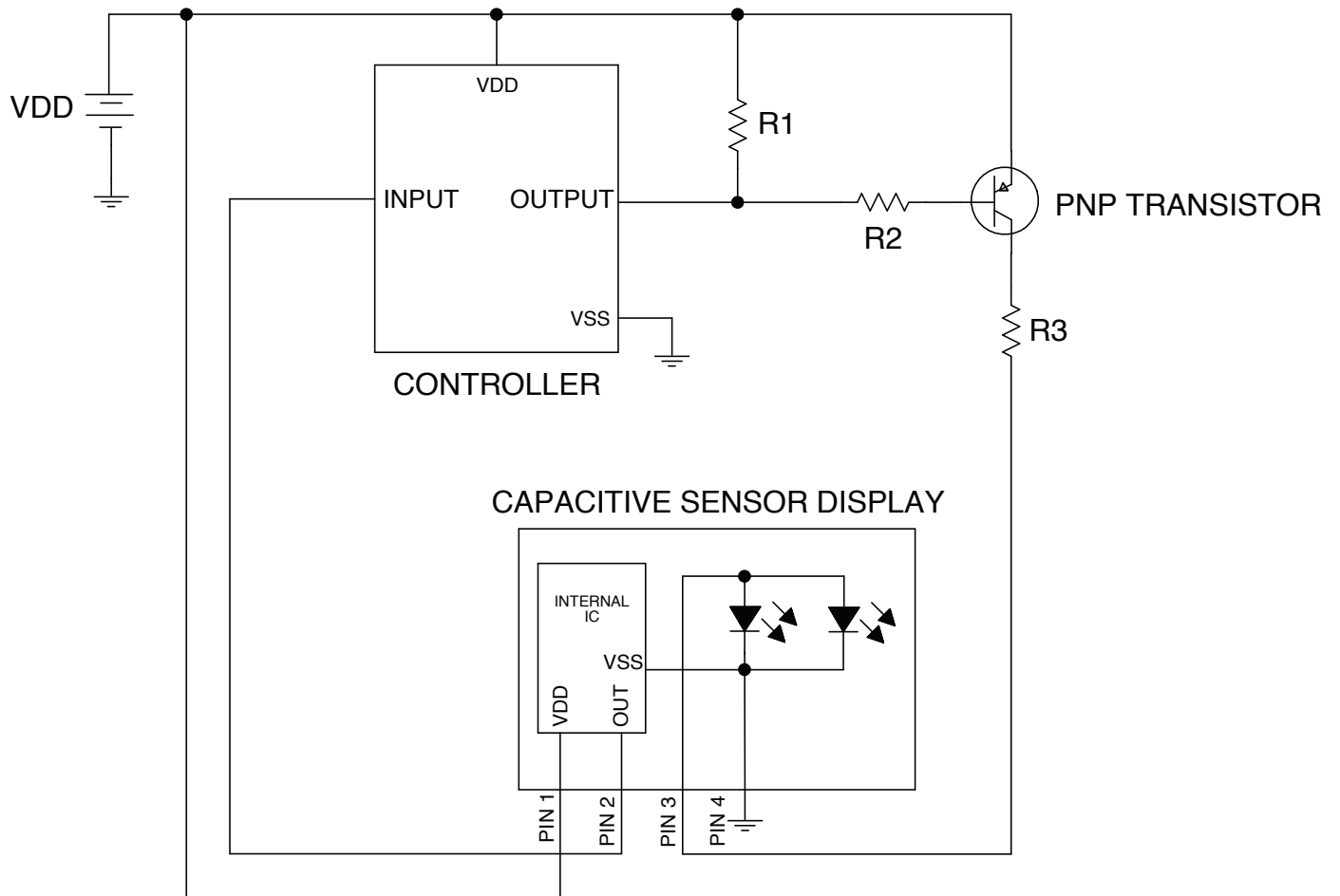
Soldering Iron: 30W Max

Temperature 350°C Max

Soldering Time: 3 Seconds Max (One Time)

Distance: 1.6mm min (From Seating Plane)

Application Circuit



Compliances and Approvals

